



BAS40W /-04 /-05 /-06

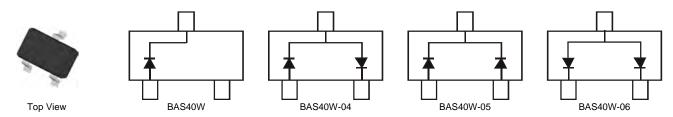
SURFACE MOUNT SCHOTTKY BARRIER DIODE

Features

- Low Forward Voltage Drop
- Fast Switching
- Ultra-Small Surface Mount Package
- PN Junction Guard Ring for Transient and ESD Protection
- Lead Free/RoHS Compliant (Note 3)
- "Green" Device (Note 4 and 5)

Mechanical Data

- Case: SOT-323
- Case Material: Molded Plastic, "Green" Molding Compound, Note 4. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Polarity: See Diagrams Below
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.006 grams (approximate)



Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	40	v
RMS Reverse Voltage	V _{R(RMS)}	28	V
Forward Continuous Current (Note 1)	I _{FM}	200	mA
Non-Repetitive Peak Forward Surge Current @ t = 1.0s	I _{FSM}	600	mA

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 1)	PD	200	mW
Thermal Resistance Junction to Ambient Air (Note 1)	$R_{ heta JA}$	625	°C/W
Operating Temperature Range	TJ	-55 to +125	۵°
Storage Temperature Range	T _{STG}	-65 to +150	٥C

Electrical Characteristics $@T_A = 25^{\circ}C$ unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 2)	V _{(BR)R}	40		V	I _R = 10μA
Forward Voltage	VF	_	380 1000	mV mV	I _F = 1.0mA, t _p < 300μs I _F = 40mA, t _p < 300μs
Leakage Current (Note 2)	I _R	_	200	nA	V _R = 30V
Total Capacitance	CT	_	5.0	pF	$V_{R} = 0, f = 1.0MHz$
Reverse Recovery Time	t _{rr}	_	5.0	ns	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \text{ x } I_R, R_L = 100 \Omega$

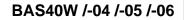
Notes: 1. Device mounted on FR4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf. 2. Short duration pulse test used to minimize self-heating effect.

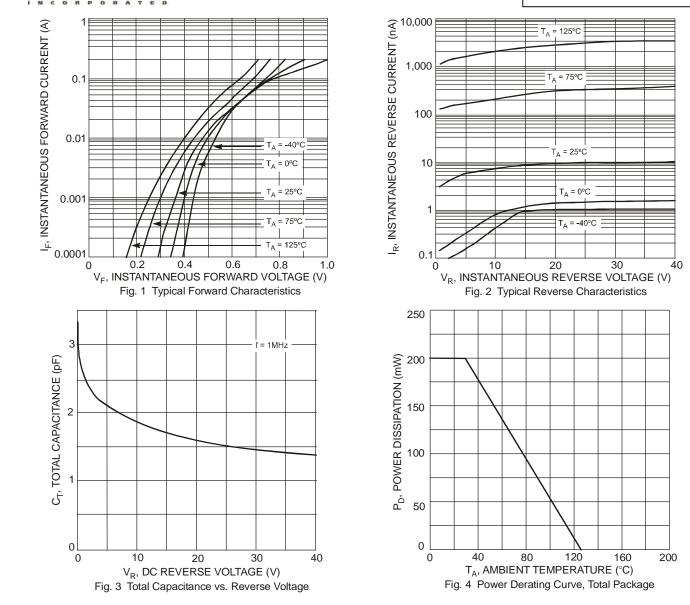
3. No purposefully added lead.

4. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.

 Product manufactured with Date Code 0627 (week 27, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0627 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.







Ordering Information (Notes 5 & 6)

Part Number	Case	Packaging
BAS40W-7-F	SOT-323	3000/Tape & Reel
BAS40W-04-7-F	SOT-323	3000/Tape & Reel
BAS40W-05-7-F	SOT-323	3000/Tape & Reel
BAS40W-06-7-F	SOT-323	3000/Tape & Reel

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information

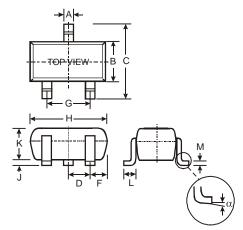
		xxx = Pro K43 = I
xxx	ΥM	K44 = I K45 = I K46 = I
		YM = Dat Y = Year M = Mont

xxx = Pr	oduct Type Marking Code
K43 =	BAS40W
K44 =	BAS40W-04
K45 =	BAS40W-05
K46 =	BAS40W-06
YM = Da	ate Code Marking
Y = Yea	r (ex: N = 2002)
M = Mor	nth (ex: 9 = September)

Date Code Key								V = V 0	nth (ex: s	9 = Sept	(ember)					
Year	2000	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012	2013	2014	2015
Code	L	М	Ν	Р	R	S	Т	U	V	W	Х	Y	Z	А	В	С
Month	Jan	F	eb	Mar	Apr	М	ay	Jun	Jul	A	ug	Sep	Oct	N	ov	Dec
Code	1		2	3	4	:	5	6	7		8	9	0	1	N	D

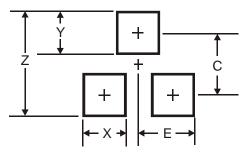


Package Outline Dimensions



SOT-323						
Dim	Min	Max	Тур			
Α	0.25	0.40	0.30			
В	1.15	1.35	1.30			
С	2.00	2.20	2.10			
D	-	-	0.65			
F	0.30	0.40	0.425			
G	1.20	1.40	1.30			
Н	1.80	2.20	2.15			
J	0.0	0.10	0.05			
κ	0.90	1.00	1.00			
L	0.25	0.40	0.30			
М	0.10	0.18	0.11			
α	0°	8°	-			
All	Dimens	ions in	mm			

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.8
Х	0.7
Y	0.9
С	1.9
E	1.0

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